

# C2012X8R1H154M125AB

TDK Item Description : C2012X8R1H154MT\*\*\*\*



## Application & Main Feature

Commercial Grade ( High Temperature Application )

## Series

C2012 [EIA CC0805]



## Dimensions

L 2.00mm +/-0.2mm  
 W 1.25mm +/-0.2mm  
 T 1.25mm +/-0.2mm  
 B 0.20mm Min.  
 G 0.50mm Min.

## Temperature Characteristic

X8R (-55 to 150 degC +/-15%)

## Rated Voltage

1H (50Vdc)

## Capacitance

150nF

## Capacitance Tolerance

M (+/-20%)

## Dissipation Factor

3% Max.

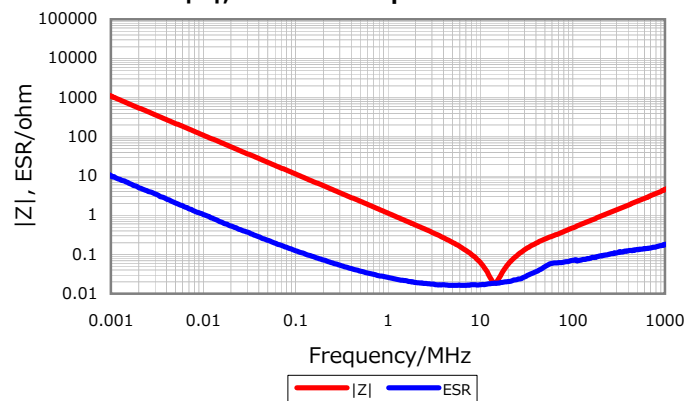
## Insulation Resistance

3.33Gohm Min.

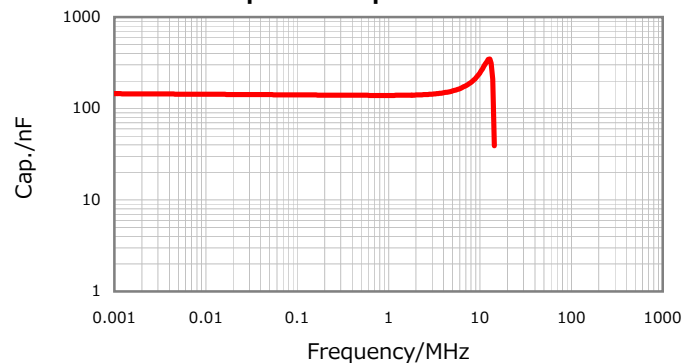
## AEC-Q200

Not Applicable

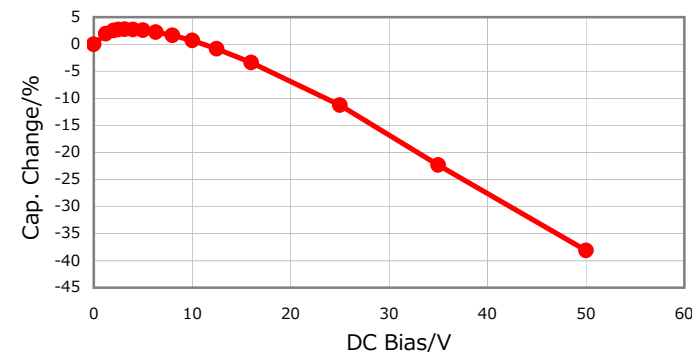
## |Z|, ESR vs. Freq. Characteristics



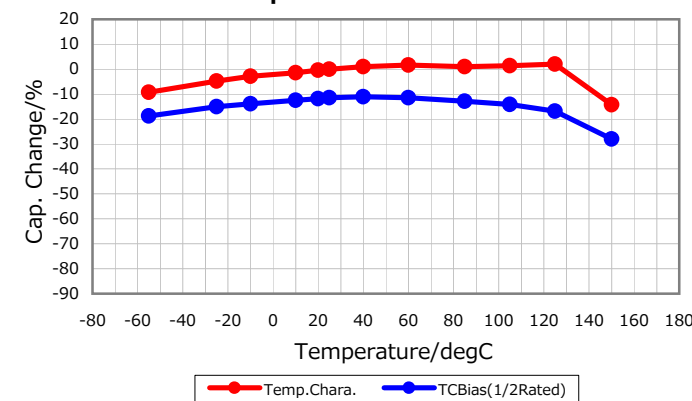
## Cap. vs. Freq. Characteristic



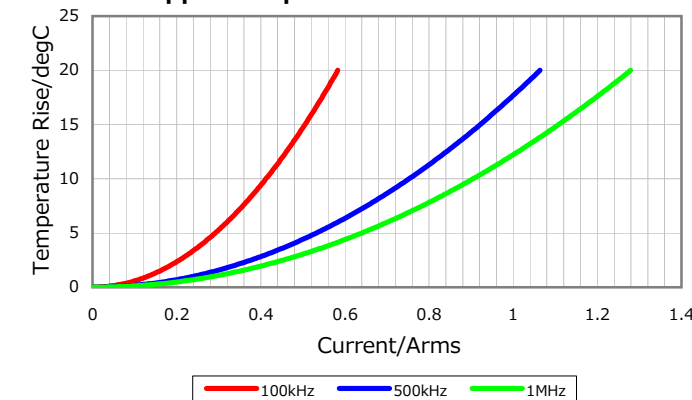
## DC Bias Characteristic



## Temperature Characteristics



## Ripple Temperature Rise Characteristics



Characterization Sheet ( Multilayer Ceramic Chip Capacitors )



All specifications are subject to change without notice.

January 3, 2016